# SiHB15N60E



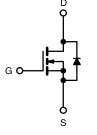


# **E Series Power MOSFET**

PRODUCT SUMMARY						
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650					
R <sub>DS(on)</sub> max. (Ω) at 25 °C	$V_{GS} = 10 V$ 0.28					
Q <sub>g</sub> max. (nC)	78					
Q <sub>gs</sub> (nC)	9					
Q <sub>gd</sub> (nC)	17					
Configuration	Single					

#### D<sup>2</sup>PAK (TO-263)





N-Channel MOSFET

#### FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>g</sub>)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION					
Package	D <sup>2</sup> PAK (TO-263)				
Lead (Pb)-free and Halogen-free	SiHB15N60E-GE3				

ABSOLUTE MAXIMUM RATINGS (T <sub>C</sub> = 25 °C, unless otherwise noted)								
PARAMETER	SYMBOL	LIMIT	UNIT					
Drain-Source Voltage			V <sub>DS</sub>	600	V			
Gate-Source Voltage			V <sub>GS</sub>	± 30	v			
	V at 10 V	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$ $T_{\rm C} = 100 \ ^{\circ}{\rm C}$	- I <sub>D</sub>	15				
Continuous Drain Current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		9.6	А			
Pulsed Drain Current <sup>a</sup>	I <sub>DM</sub>	39						
Linear Derating Factor		1.4	W/°C					
Single Pulse Avalanche Energy <sup>b</sup>	E <sub>AS</sub>	102	mJ					
Maximum Power Dissipation	PD	180	W					
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C					
Drain-Source Voltage Slope $V_{DS} = 0 V to 80 \% V_{DS}$			-11//-14	70				
Reverse Diode dV/dt <sup>d</sup>	dV/dt	7.7	V/ns					
Soldering Recommendations (Peak temperature) <sup>c</sup>		300	°C					

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 11.6 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 4.2 A.

c. 1.6 mm from case.

d.  $I_{SD} \leq I_D$ , dI/dt = 100 A/µs, starting  $T_J$  = 25 °C.

S16-0799-Rev. F, 02-May-16

1 For technical questions, contact: <u>hvm@vishay.com</u>



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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP. MAX.			UNIT			
Maximum Junction-to-Ambient	R <sub>thJA</sub>	- 62						
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	- 0.7				°C/W		
SPECIFICATIONS (T_J = 25 $^\circ\text{C},\text{u}$	inless otherwi	se noted)						
PARAMETER	SYMBOL	TEST		IONS	MIN.	TYP.	MAX.	UNIT
Static						•	•	
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> =	250 µA	600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.71	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{GS}$ , $I_D =$	250 µA	2	-	4	V
Onto Course Laskana		,	$V_{\rm GS} = \pm 20$	V	-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>		$V_{\rm GS} = \pm 30$	V	-	-	± 1	μA
Zava Cata Valtaga Drain Current		V <sub>DS</sub> =	600 V, V <sub>C</sub>	<sub>as</sub> = 0 V	-	-	1	μA
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V	V, T <sub>J</sub> = 125 °C	-	-	10	
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$			-	0.23	0.28	Ω
Forward Transconductance	9 <sub>fs</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 8 A			-	4.6	-	S
Dynamic		•			-	•	•	•
Input Capacitance	C <sub>iss</sub>	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz			-	1350	-	pF
Output Capacitance	C <sub>oss</sub>				-	70	-	
Reverse Transfer Capacitance	C <sub>rss</sub>				-	5	-	
Effective Output Capacitance, Energy Related <sup>a</sup>	C <sub>o(er)</sub>			-	53	-		
Effective Output Capacitance, Time Related <sup>b</sup>	C <sub>o(tr)</sub>	$V_{DS} = 0 V$ to 480 V, $V_{GS} = 0 V$			-	177	-	
Total Gate Charge	Qg				-	39	78	
Gate-Source Charge	Q <sub>gs</sub>	$V_{GS} = 10 V$	V <sub>GS</sub> = 10 V I <sub>D</sub> = 8 A		-	11	-	nC
Gate-Drain Charge	Q <sub>gd</sub>				-	17	-	
Turn-On Delay Time	t <sub>d(on)</sub>				-	16	32	
Rise Time	t <sub>r</sub>	V <sub>DD</sub> :	= 480 V, I <sub>D</sub>	= 8 A.	-	26	52	ns
Turn-Off Delay Time	t <sub>d(off)</sub>		10 V, R <sub>g</sub>		-	41	82	
Fall Time	t <sub>f</sub>				-	22	44	
Gate Input Resistance	R <sub>g</sub>	f = 1 MHz, open drain			0.3	0.86	1.7	Ω
Drain-Source Body Diode Characteristic	cs							_
Continuous Source-Drain Diode Current	I <sub>S</sub>	showing the	MOSFET symbol showing the		-	-	15	
Pulsed Diode Forward Current	I <sub>SM</sub>	integral reverse		-	-	60	A	
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °	C, I <sub>S</sub> = 8 A	, V <sub>GS</sub> = 0 V	-	1.0	1.2	V
Reverse Recovery Time	t <sub>rr</sub>				-	302	604	ns
Reverse Recovery Charge	Q <sub>rr</sub>	$T_J = 25 \text{ °C}, I_F = I_S = 8 \text{ A},$ dI/dt = 100 A/µs, V <sub>R</sub> = 25 V			-	4.0	8	μC
Reverse Recovery Current	I <sub>RRM</sub>				-	24	-	Α

#### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ .

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS.



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### TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

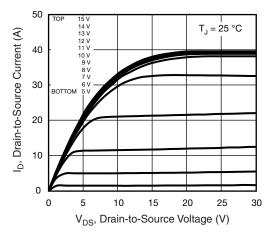


Fig. 1 - Typical Output Characteristics

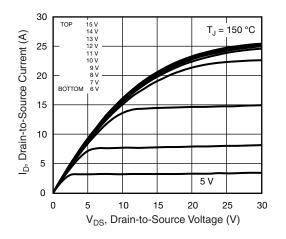


Fig. 2 - Typical Output Characteristics

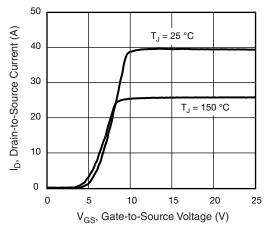


Fig. 3 - Typical Transfer Characteristics

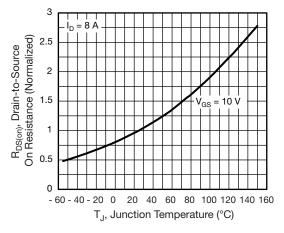


Fig. 4 - Normalized On-Resistance vs. Temperature

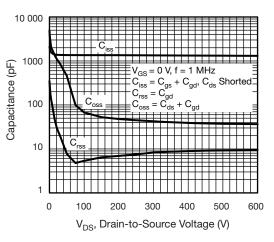


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

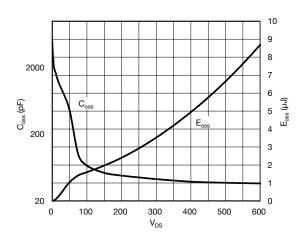


Fig. 6 -  $C_{\rm oss}$  and  $E_{\rm oss}$  vs.  $V_{\rm DS}$ 

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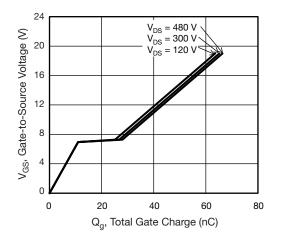


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

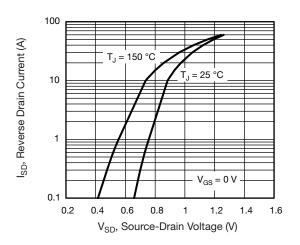


Fig. 8 - Typical Source-Drain Diode Forward Voltage

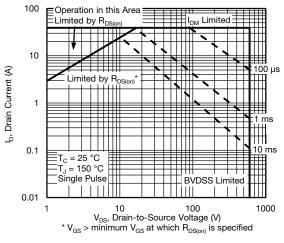


Fig. 9 - Maximum Safe Operating Area

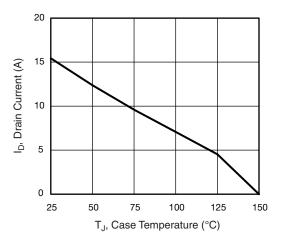


Fig. 10 - Maximum Drain Current vs. Case Temperature

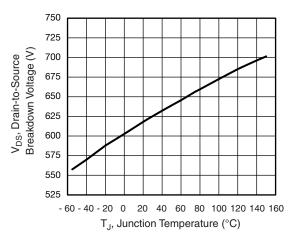
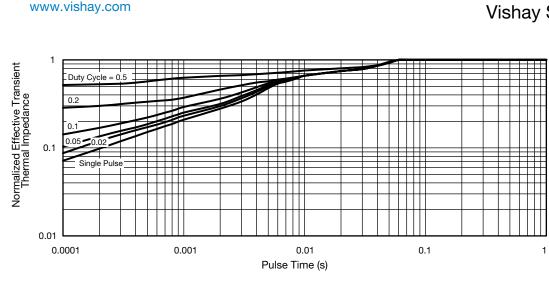


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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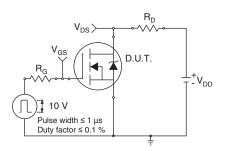


Fig. 13 - Switching Time Test Circuit

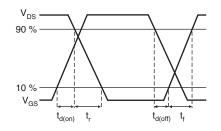


Fig. 14 - Switching Time Waveforms

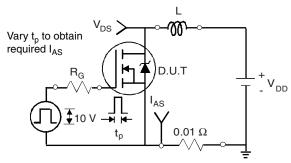


Fig. 15 - Unclamped Inductive Test Circuit

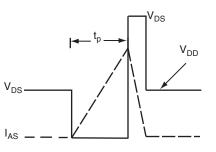


Fig. 16 - Unclamped Inductive Waveforms

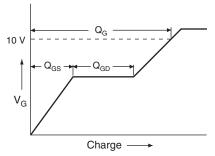
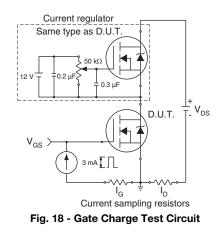


Fig. 17 - Basic Gate Charge Waveform

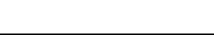


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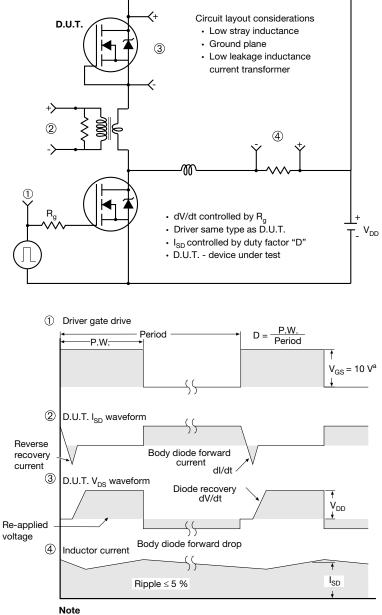


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#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5$  V for logic level devices

Fig. 19 - For N-Channel

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### **TO-263AB (HIGH VOLTAGE)**

/3

ВH B 4

A

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∕₅∖

Detail A

(Datum A)

D

 $\underline{4}$ 11

		→  ←	-2 x b2 2 x b ⊕0.010@A( P	DB Lating (c) (c) (c) (c) (c) (c) (b, b) <u>Section B -</u> Scale	$c \rightarrow \bullet$ $\pm 0.004 \textcircled{0} B$ Base $d \rightarrow d \rightarrow$	• •			1 4		
	MILLIN	MILLIMETERS INCHES		HES			MILLIMETERS			INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.		DIM.	MIN.	MAX.	MIN.	MA	
А	4.06	4.83	0.160	0.190		D1	6.86	-	0.270	-	
A1	0.00	0.25	0.000	0.010		E	9.65	10.67	0.380	0.4	
b	0.51	0.99	0.020	0.039		E1	6.22	-	0.245	-	
b1	0.51	0.89	0.020	0.035		е	2.54 BSC		0.100	) BSC	
b2	1.14	1.78	0.045	0.070		Н	14.61	15.88	0.575	0.6	
b3	1.14	1.73	0.045	0.068		L	1.78	2.79	0.070	0.1	
С	0.38	0.74	0.015	0.029		L1	-	1.65	-	0.0	
c1	0.38	0.58	0.015	0.023		L2	-	1.78	-	0.0	
c2	1.14	1.65	0.045	0.065		L3	0.25 BSC		0.010 BSC		

Α

ECN: S-82110-Rev. A, 15-Sep-08 DWG: 5970

8.38

Notes

D

9.65

0.330

0.380

2. Dimensions are shown in millimeters (inches).

3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body at datum A.

L4

5.28

0.188

4.78

4. Thermal PAD contour optional within dimension E, L1, D1 and E1.

- 5. Dimension b1 and c1 apply to base metal only.
- 6. Datum A and B to be determined at datum plane H.
- 7. Outline conforms to JEDEC outline to TO-263AB.



H

A1

B

Gauge plane 0° tọ 8°

L3

Detail "A" Rotated 90° CW

coolo 8.1

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Seating plane

MAX.

0.420

-

0.625

0.110 0.066

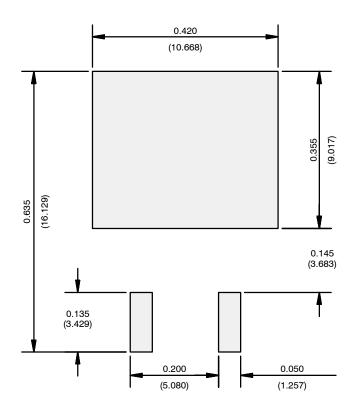
0.070

0.208

<sup>1.</sup> Dimensioning and tolerancing per ASME Y14.5M-1994.



### **RECOMMENDED MINIMUM PADS FOR D<sup>2</sup>PAK: 3-Lead**



Recommended Minimum Pads Dimensions in Inches/(mm)

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